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10/06875

03/04/02

U.S. UTILITY Patent Application

PATENT NUMBER and
ISSUE DATE

APPL NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10086875	03/04/2002	438 257	101+	2815	NEWM BERTZKY

**APPLICANTS: Watanabe Masaki; 2813

**CONTINUING DATA VERIFIED:

THIS APPLICATION IS A DIV OF 09/484,024 01/18/2000 PAT 6,355,978

** FOREIGN APPLICATIONS VERIFIED:

JAPAN HEI 11-204930 07/19/1999

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PG-PUB	DO NOT PUBLISH <input type="checkbox"/>	RESCIND <input type="checkbox"/>
Foreign priority claimed	<input type="checkbox"/> yes <input type="checkbox"/> no	ATTORNEY DOCKET NO
35 USC 119 conditions met	<input type="checkbox"/> yes <input type="checkbox"/> no	50090-465
Verified and Acknowledged Examiners's initials		
TITLE : Package for accommodating electronic parts, semiconductor device and method for manufacturing package		

U.S. DEPT. OF COMM./PAT. & TM.-PTO-436L (Rev. 12-94)

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G.
Assistant Examiner			
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
Primary Examiner			
PREPARED FOR ISSUE		Application Examiner	
<input type="checkbox"/> TERMINAL DISCLAIMER		WARNING: The information disclosed herein may be restricted. Unauthorized disclosure may be prohibited by the United States Code Title 35, Sections 122, 181 and 368, Possession outside the U.S. Patent & Trademark Office is restricted to authorized employees and contractors only.	

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